

AMENDMENTS TO THE SPECIFICATION:

Please amend the paragraph set forth in the Preliminary Amendment filed October 2, 2003 that replaced page 1, lines 1-2 of the specification, which originally read "Specification" and "Plasma Processing Apparatus and Plasma Processing Method," as follows:

This is a continuation of Application No. 09/720,910 filed January 2, 2001, now pending U.S. Patent No. 6,676,804 B1, which is a National Stage under 35 U.S.C. §371 of International Application No. PCT/JP99/03846 filed July 16, 1999, all of which are incorporated herein by reference.